

ATTY DKT. No.: AMAT/8451/CMP/ECP/RKK  
U.S. SERIAL NO.: UNASSIGNED  
FILED: HEREWITH  
APPLICANT: APPLIED MATERIALS  
TITLE: COPPER REPLENISHMENT FOR COPPER PLATING WITH  
INVENTOR: INSOLUBLE ANODE  
EXPRESS MAIL No.: KOVARSKY, ET AL.  
EV351032102US

CONF. No.: UNKNOWN

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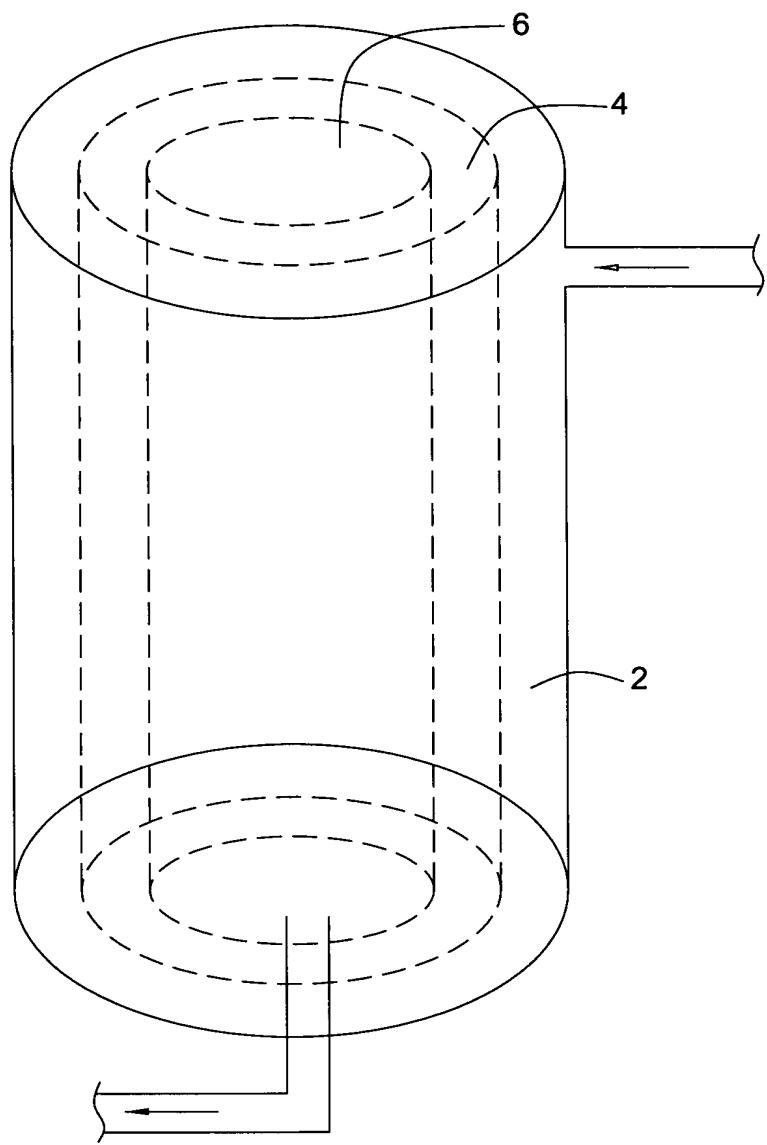


FIG. 1A  
( PRIOR ART )

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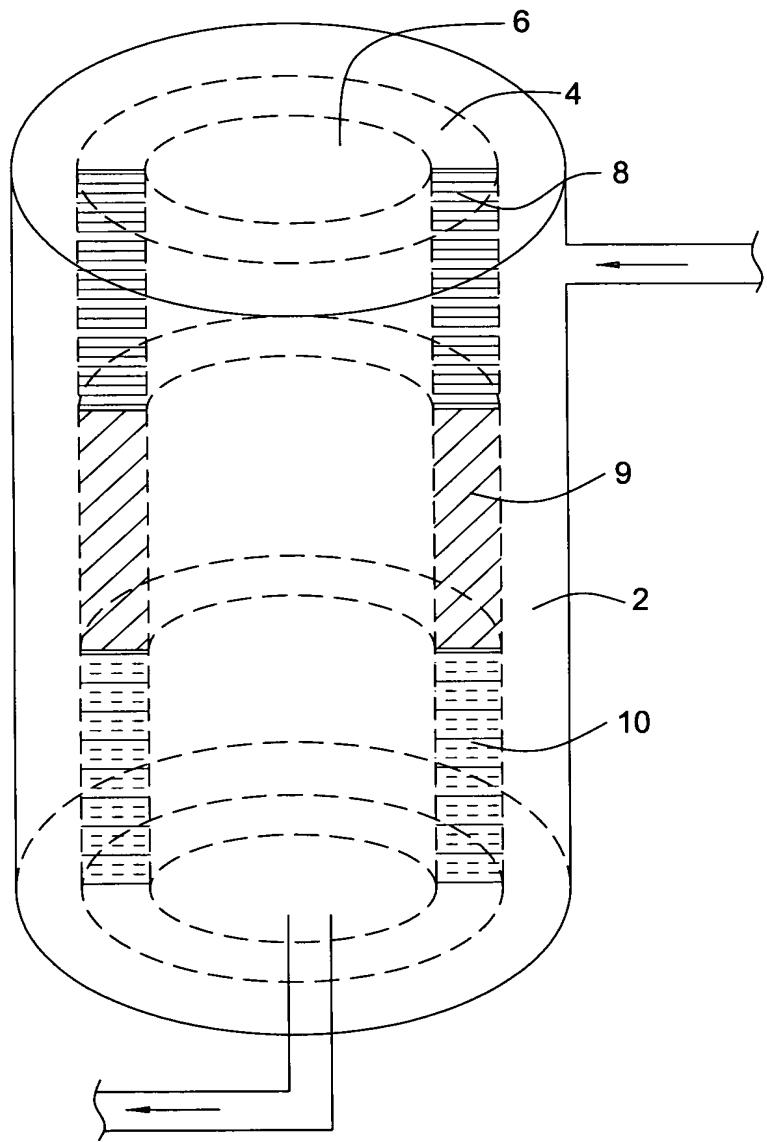


FIG. 1B  
( PRIOR ART )

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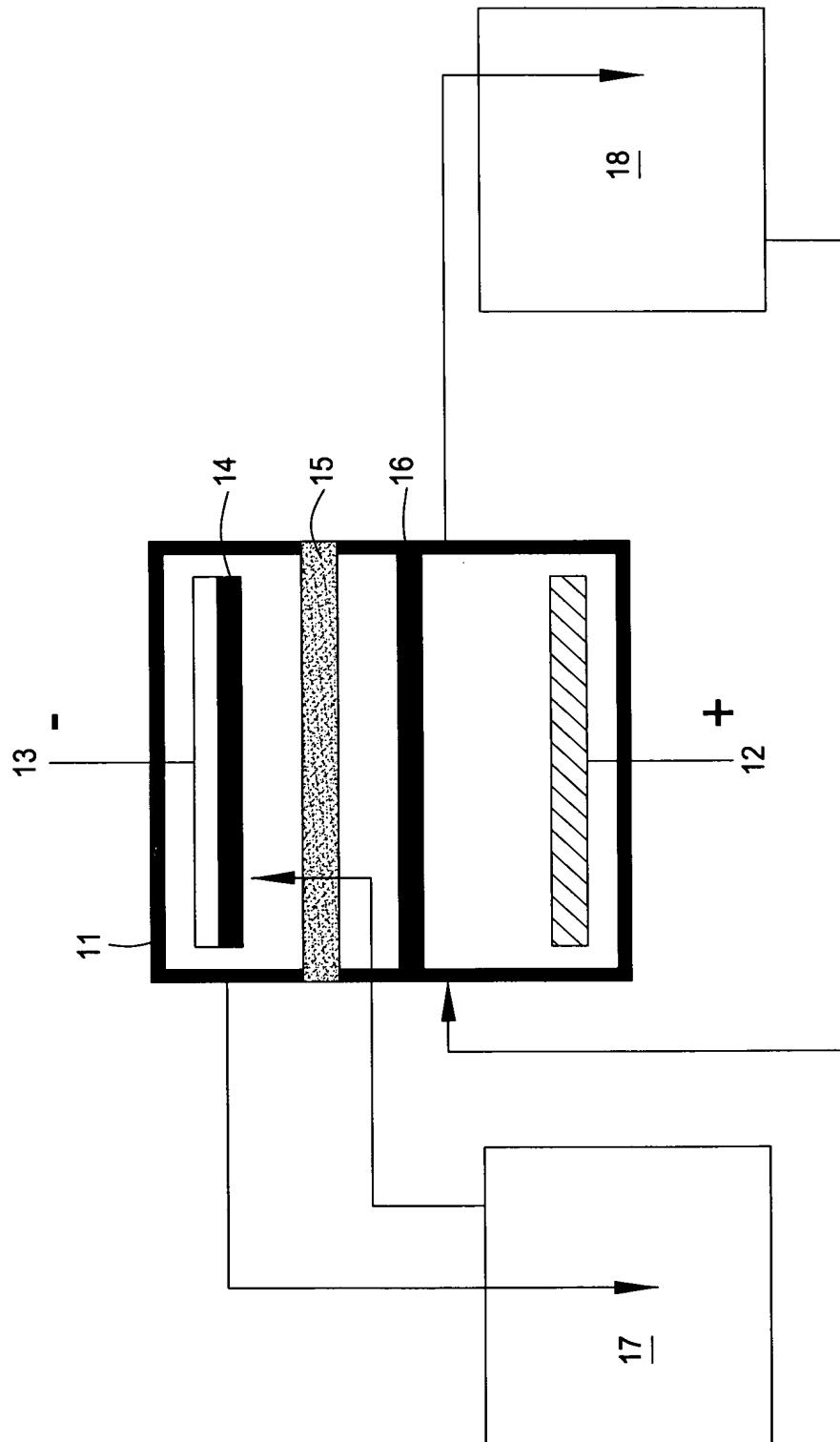


FIG. 2

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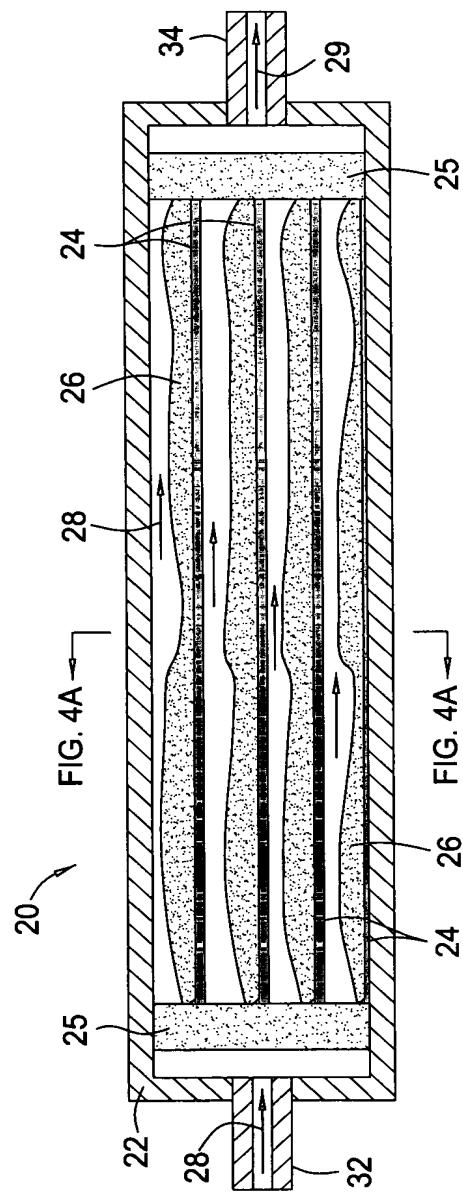


FIG. 3

FIG. 4A → FIG. 4A →

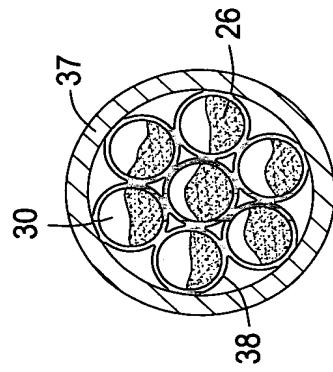


FIG. 4C

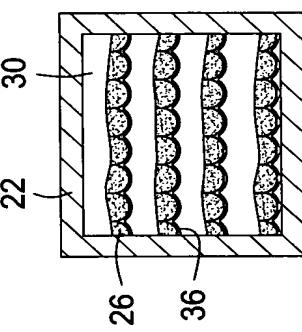


FIG. 4B

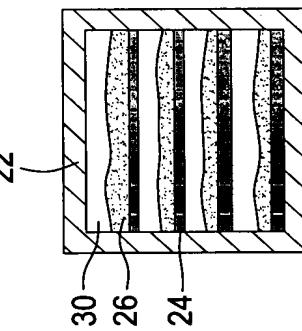


FIG. 4A

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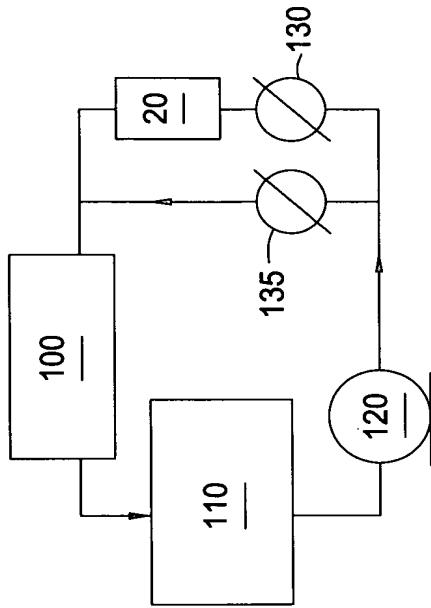


FIG. 5B

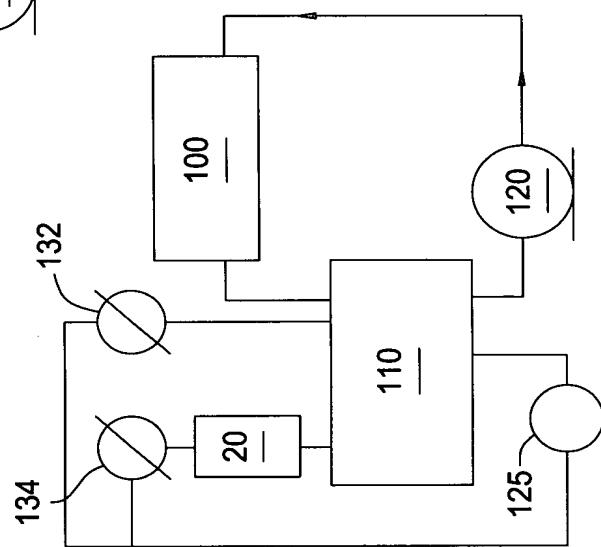


FIG. 5C

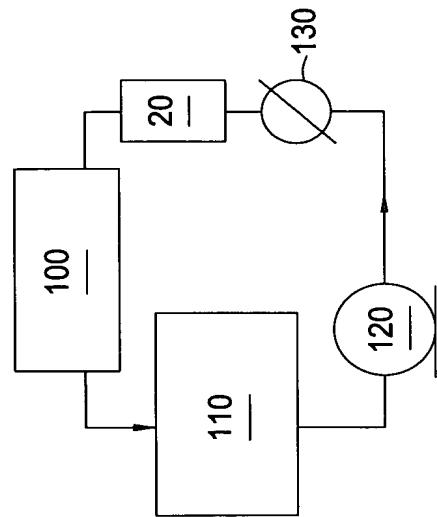


FIG. 5A

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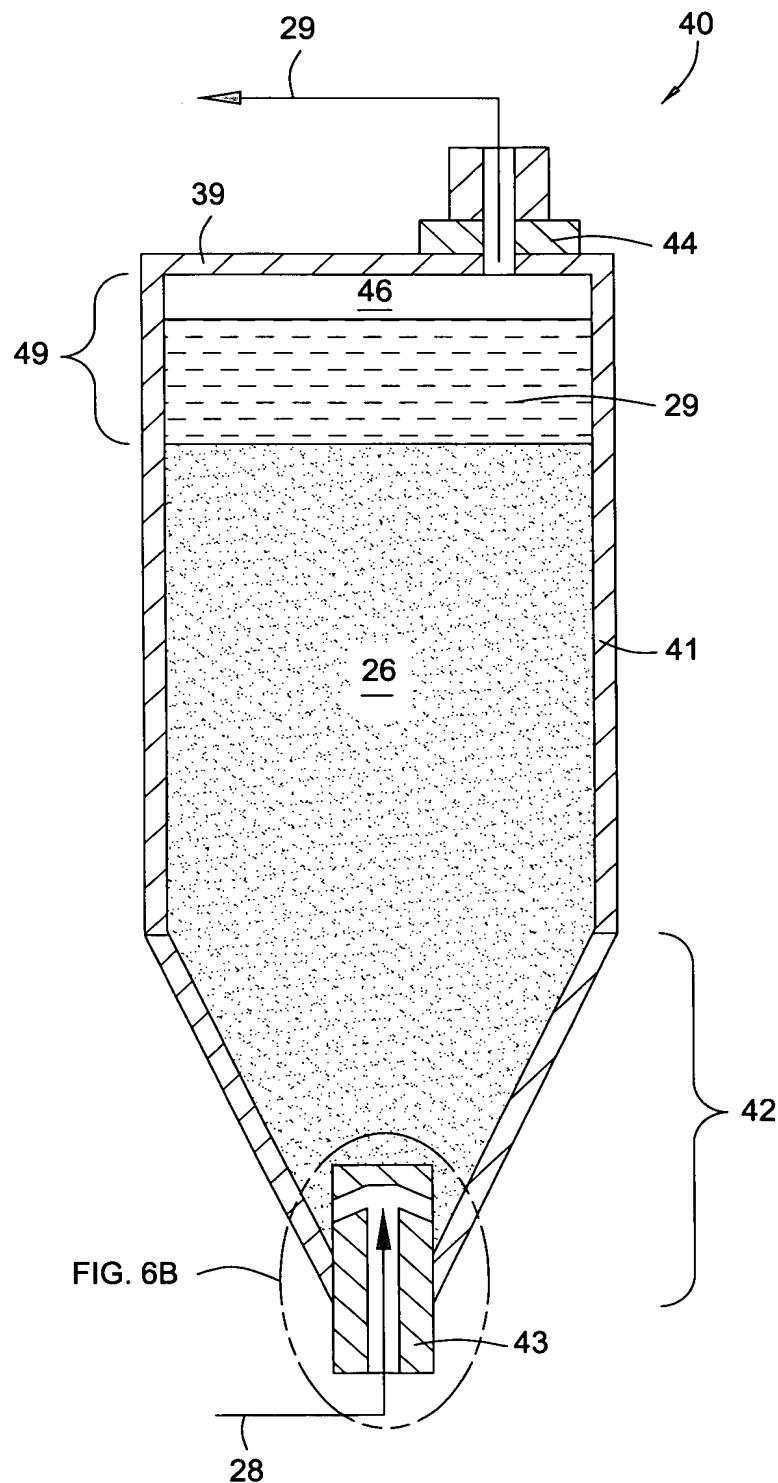


FIG. 6A

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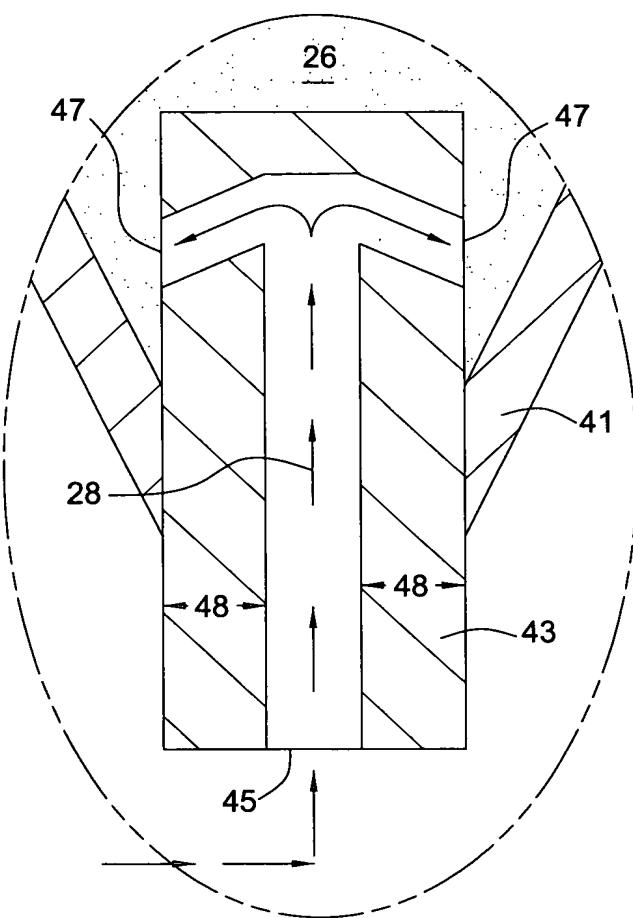


FIG. 6B

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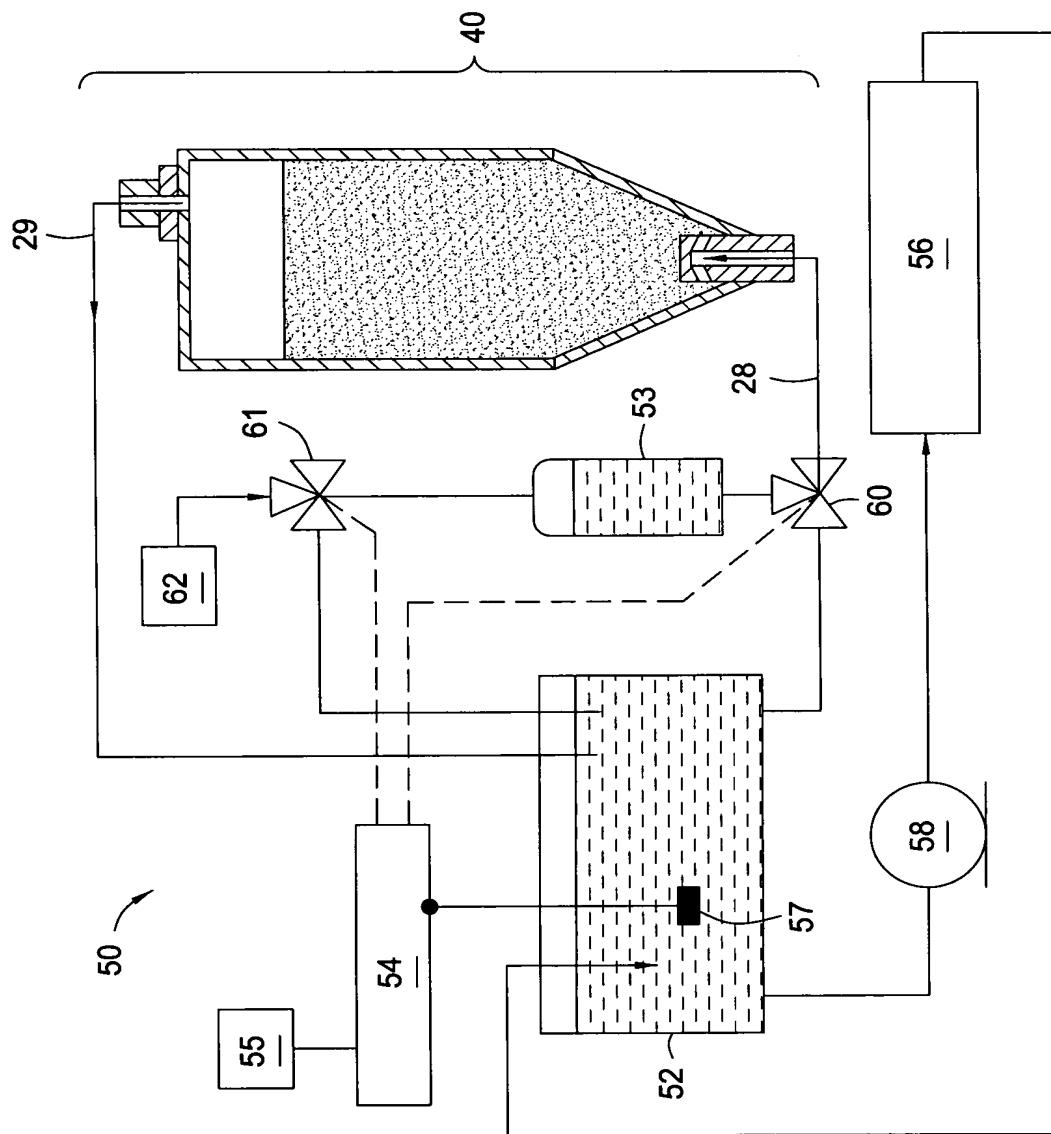


FIG. 7

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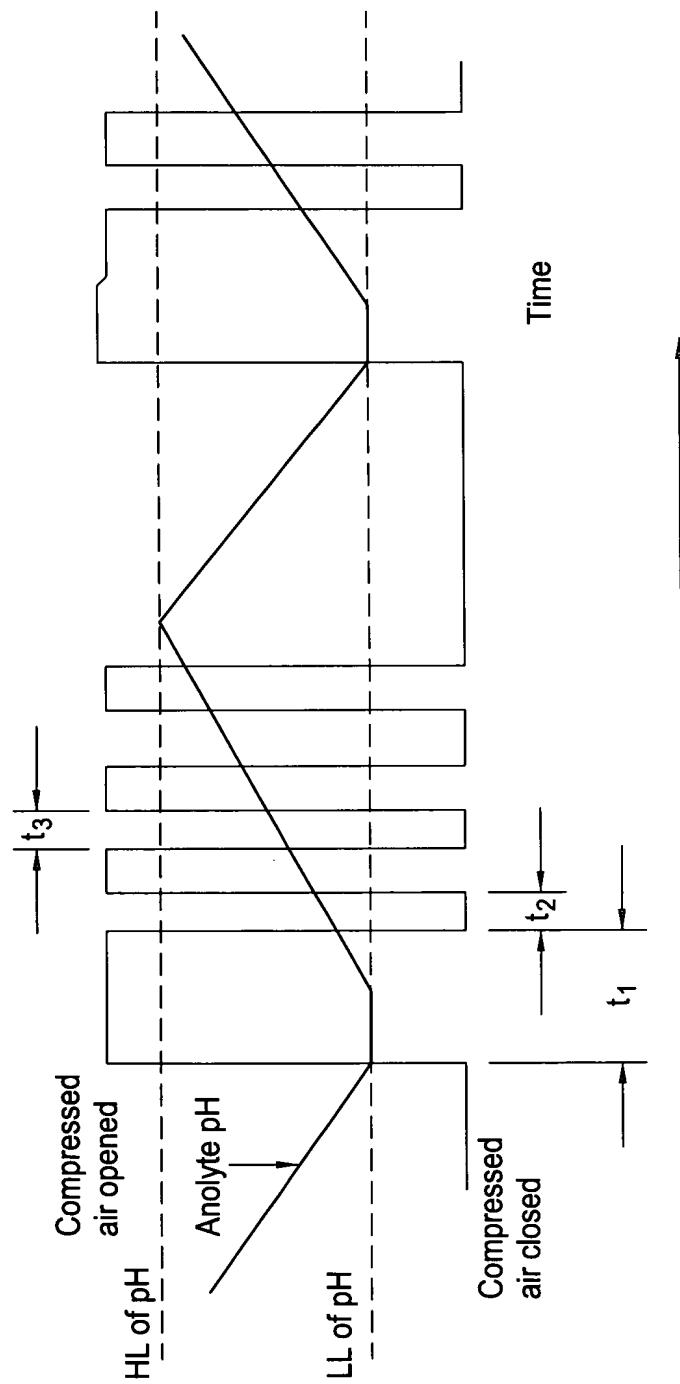


FIG. 8

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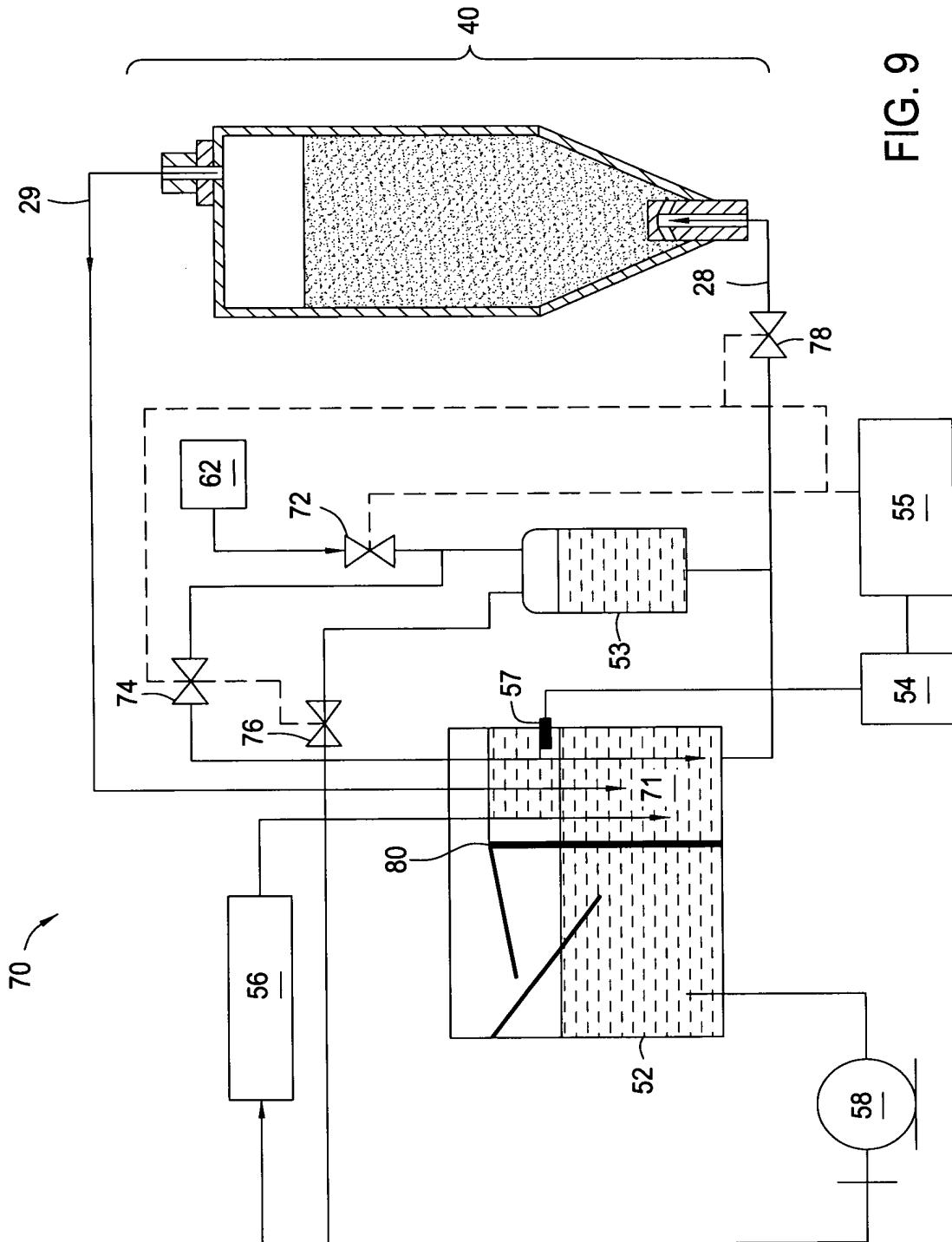


FIG. 9

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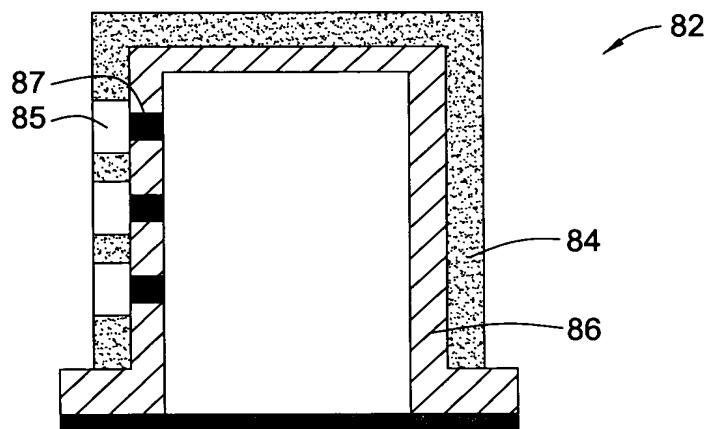


FIG. 10A

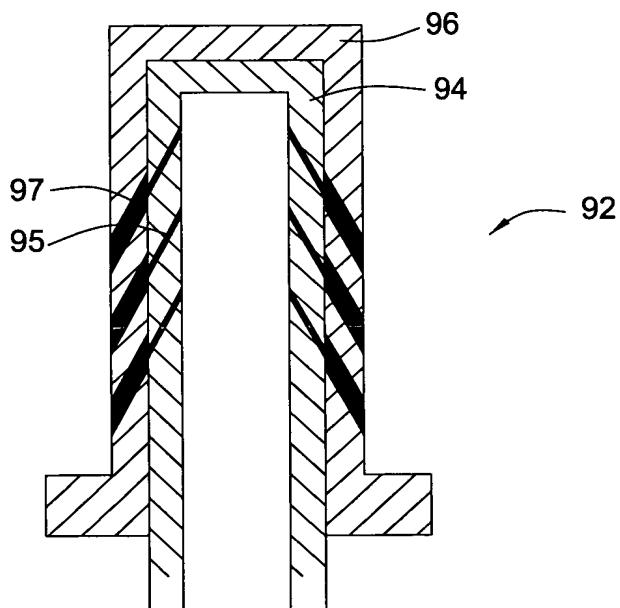


FIG. 10B